Surface Mount NPN General Purpose Transistor

2N222AUATXV (Not Recommended for New Design)
2N2222AUATX (Not Recommended for New Design)

Features:

- · Ceramic 4 pin surface mount package
- Small package to minimize circuit board area
- Hermetically sealed
- Processed per MIL-PRF-19500/255





Description:

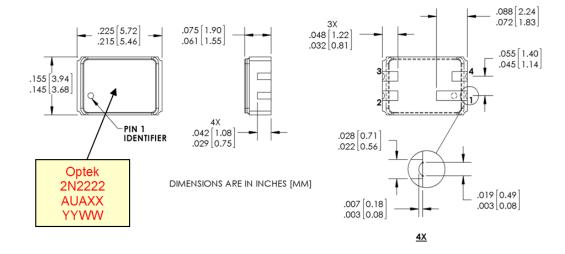
The 2N2222AUA (TX & TXV - NRND) is a hermetically sealed ceramic surface mount general purpose switching transistor. The four pin ceramic package is ideal for designs where board space and device weight are important design considerations. The "UA" suffix denotes the 4 terminal leadless chip carrier package, type "A" per MIL-PRF-19500/255.

Typical screening per MIL-PRF-19500/255. The burn-in condition is V_{CB} = 30 V. P_D = 400 mW, T_A = 25° C, t = 80 hrs. Refer to MIL-PRF-19500/255 for complete requirements. In addition, the TX and TXV versions receive 100 % thermal response testing.

When ordering parts without processing, do not use the TX or TXV suffix.

Applications:

- General switching
- Amplification
- Signal processing
- Radio transmission
- Logic gates



Pin	Function				
1	Collector				
2	Emitter				
3	Base				
4	No Connection				

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Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Collector-Base Voltage	75 V
Collector-Emitter Voltage	50 V
Emitter-Base Voltage	6.0 V
Collector Current-Continuous	800 mA
Operating Junction Temperature (T _J)	-65° C to +200° C
Storage Junction Temperature (T _{stg})	-65° C to +200° C
Power Dissipation @ T _A = 25° C	0.5 W
Power Dissipation @ T_C = 25° $C^{(1)}$	1.16 W
Soldering Temperature (vapor phase reflow for 30 seconds)	215° C
Soldering Temperature (heated collet for 5 seconds)	260° C

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER		MAX	UNITS	TEST CONDITIONS			
OFF CHARACTERISTICS								
V _{(BR)CBO}	Collector-Base Breakdown Voltage	75	-	V	$I_C = 10 \mu A, I_E = 0$			
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	50	-	V	I _C = 10 mA, I _B = 0			
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	6.0	-	V	$I_E = 10 \mu A, I_C = 0$			
I _{CBO}	Collector-Base Cutoff Current	-	10	nA	V _{CB} = 60 V, I _E = 0			
		-	10	μΑ	V _{CB} = 60 V, I _E = 0, T _A = 150° C			
I _{EBO}	Emitter-Base Cutoff Current	-	10	nA	V _{EB} = 4 V, I _C = 0			
I _{CES}	Collector Emitter Cutoff Current	-	50	nA	V _{CE} = 50 V			
ON CHARACTERISTICS								
h _{FE}	Forward-Current Transfer Ratio	50	-	-	V _{CE} = 10 V, I _C = 0.1 mA			
		75	325	-	V _{CE} = 10 V, I _C = 1.0 mA			
		100	-	-	V _{CE} = 10 V, I _C = 10 mA			
		100	300	-	V _{CE} = 10 V, I _C = 150 mA ⁽²⁾			
		30	-	-	V _{CE} = 10 V, I _C = 500 mA ⁽²⁾			
		35	-	-	V _{CE} = 10 V, I _C = 10 mA, T _A = -55° C			

Note:

- 1. Derate linearly 6.6 mW/° C above 25° C
- 2. Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0 %

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Electrical Specifications

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS			
ON CHARACTERISTICS								
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	-	0.3	V	I _C = 150 mA, I _B = 15 mA ⁽²⁾			
		-	1.0	V	I _C = 500 mA, I _B = 50 mA ⁽²⁾			
V _{BE(SAT)}	Base-Emitter Saturation Voltage	0.6	1.2	V	I _C = 150 mA, I _B = 15 mA ⁽²⁾			
		-	2.0	V	I _C = 500 mA, I _B = 50 mA ⁽²⁾			
SMALL-SIGNAL CHARACTERISTICS								
h _{fe}	Small Signal Forward Current Transfer Ratio	50	-	-	V _{CE} = 10 V, I _C = 1.0 mA, f = 1.0 kHz			
h _{fe}	Small Signal Forward Current Transfer Ratio	2.5	-	-	V _{CE} = 20 V, I _C = 20 mA, f = 100 MHz			
C _{obo}	Open Circuit Output Capacitance	-	8.0	pF	V _{CB} = 10 V, 100 kHz ≤ f ≤ 1.0 MHz			
C _{ibo}	Input Capacitance (Output Open)	-	25	pF	V _{EB} = 0.5 V, 100 kHz ≤ f ≤ 1.0 MHz			
SWITCHING CHARACTERISTICS								
t _{on}	Turn-On Time	-	35	ns	V _{CC} = 30 V, I _C = 150 mA, I _{B1} = 15 mA			
t _{off}	Turn-Off Time	-	300	ns	V _{CC} = 30 V, I _C = 150 mA, I _{B1} = I _{B2} = 15 mA			